## I claim:

- A susceptor for supporting a semiconductor wafer, comprising:
- a surface for supporting a semiconductor wafer, said surface having a concave shape; and
- a heater thermally coupled to said surface for heating said surface.
- 2. The susceptor according to claim 1, wherein said surface has a center portion and an outer portion surrounding said center portion, and wherein a distance between said center portion and a plane defined by a circle along said outer portion is greater than 200  $\mu m\,.$
- 3. The susceptor according to claim 2, wherein said distance is greater than 500  $\mu\text{m}\,.$
- 4. The susceptor according to claim 2, wherein said circle is defined with a diameter of substantially 300  $\,\mathrm{mm}\,.$
- 5. The susceptor according to claim 1, wherein said susceptor is formed of metal.

- 6. The susceptor according to claim 1, wherein said heater is configured to heat the wafer to a temperature of at least 400°C.
- 7. The susceptor according to claim 1 configured to carry a silicon wafer with a diameter of at least 300 mm.
- 8. The susceptor according to claim 1, wherein said surface is formed with a plurality of concentric, projecting rings.